SHIGA7.049APC PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Washio et al.

Appl. No. : 10/578,398

Filed : May 4, 2006

For : THICK FILM PHOTORESIST

COMPOSITION AND METHOD

OF FORMING RESIST PATTERN

Examiner : Walke, A.

Group Art Unit : 1795

AMENDMENT AND RESPONSE TO OFFICE ACTION

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed January 9, 2008, please consider the following amendments and remarks.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 4 of this paper.